



# 587 SERIES 5050 ADDRESSABLE RGB LED

#### MECHANICAL / SPECIFICATIONS

PART NUMBER: 587-2056-147F

DIMENSIONS:

5.0 x 5.0 x 1.60mm

LENS COLOR: Clear

LENS MATERIAL: Silicone

# CONTROL WIRES:

Single Wire

STANDARD PACKAGING:

1000 pcs on 7 inch Reel

MOISTURE SENSITIVITY LEVEL: 5a

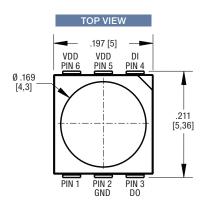
### CERTIFICATIONS & RATINGS ROHS Compliant

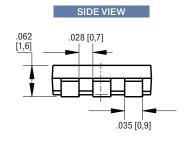
#### **FEATURES & BENEFITS**

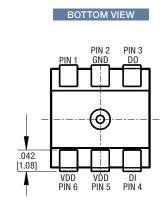
SMD LED + IC

- 5050 package size, single wire, 24 bit data frame
- Support signal reshaping to pass control waveforms to next adjacent driver
- · Cascading port transmission by a single data line
- · Built in current regulator, three way drive
- Optional maximal drive current: 20mA
- 256 step gray scale output to allow 16,777,216 color display
- Built in oscillator 20MHz
- LED driver port maximum withstand Voltage 6.5V
- Built in power on reset (2.6V) (@VDD=5V)
- Operating Voltage Range: 4.5V ~ 5.5V

#### **DIMENSIONS** inches [mm]

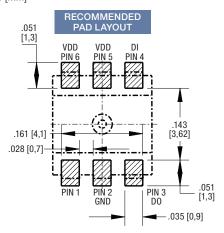


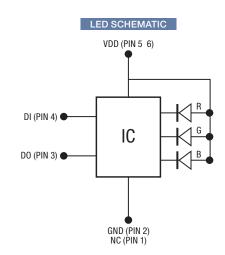






#### **DIMENSIONS** inches [mm]





## ELECTRICAL - OPTICAL CHARACTERISTICS (T soldering 25°C) Test Condition: @5V/ Ts= 25°C; Tolerance: $\pm 10\%$

Emitting Color	Material	Dominant Wa	velength (nm)	Lumi	nous Intensity (	mcd)	Viewing
Ellittilig Goldi	ivialeriai	Min.	Max.	Max. Min.		Max.	Angle
R	AllnGaP	615	630	360	600	900	120
G	InGaN	515	535	560	900	1800	120
В	InGaN	460	476	112	250	450	120

#### ABSOLUTE MAXIMUM RATINGS (TA=25°C)

Symbol	Parameter	Range	Units
$V_{\scriptscriptstyle DD}$	Supply Voltage	6.5	V
$P_{_{\mathrm{D}}}$	Power Dissipation	<400	mW
I <sub>LEDOUT</sub>	Maximum Output Current	25	mA
$T_M$	Welding Temperature	300(8S)	°C
T <sub>OPR</sub>	Operating Temperature Range	-45~85	°C
T <sub>STO</sub>	Storage Temperature Range	-45~120	°C
$V_{ESD}$	ESD(HBM)	>2K	V

#### ELECTRICAL CHARACTERISTICS (TA = 25°C VDD = 5V)

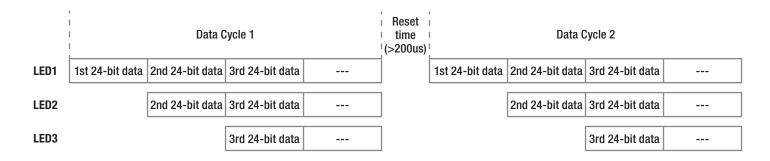
Symbol	Parameter	Min.	Тур.	Max.	Units	Note
V <sub>DD</sub>	Supply Voltage	4.5	5.0	5.5	V	-
I <sub>DD</sub>	Operation Current	-		2	mA	R,G,B on load
V <sub>IH</sub>	Input High "H" of DI	2.7	·	$V_{_{\mathrm{DD}}}$	V	-
V <sub>IL</sub>	Input Low "L" of DI	0		1.0	V	-
R <sub>PD</sub>	Pull Down Resistance	·	500k	-	Ω	DI, DO
V <sub>OH</sub>	Output High "H" of DO	4.5	-	-	V	I <sub>OH</sub> =4mA
V <sub>OL</sub>	Output Low "L" of DO	·	·	0.4	V	I <sub>oL</sub> =4mA
I <sub>SINK</sub>	R, G, B Sink Current	19	20	21	mA	V0=VDD-3.0V @VDD=5V
I <sub>LEAK</sub>	Input Leakage	-	-	1	μΑ	DI=VDD
L <sub>OFF</sub>	R, G, B Off Leakage Current	-	-	1	μΑ	PWM=0(off) @R, G, B=5V



#### DYNAMIC CHARACTERISTICS (TA=25°C)

Symbol	Parameter	Min.	Тур.	Max.	Units	Note
tPLZ	Dropogation delay time	-	-	300	ns	DI .DO CI 1555 DI 1010
tPZL	Propagation delay time	-	-	300	ns	DI→DO, CL=15pF, RL=10kΩ
tTZL	Rising time	-		200	ns	D C D 20mA CL 20nF
tTHZ	Falling time	-		200	ns	R, G, B=20mA, CL=30pF
F <sub>DATA</sub>	Data rate		800	-	kHZ	

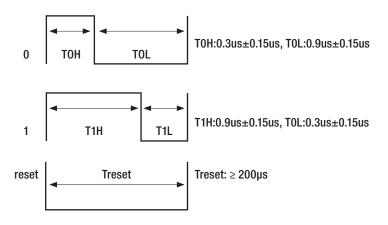
#### CASCADING DATA STRUCTURE



The single wire data transfer protocol supports 24-bit data for each LED RGB display data refresh. THE IC receives 24-bit data and passes the remaining data to next LED. The 24-bit data consist of red, green and blue data, each with 8-bit width, and are transferred with MSB first.

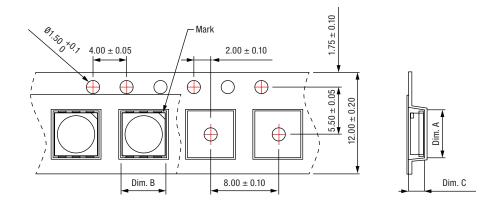
R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	GO	B7	B6	B5	B4	В3	B2	B1	В0
								<b></b>		5.5		0.0			""								

The transferred data are recognized based on the pulse widths received by THE IC. A low bit 0 is represented by a  $0.3\mu s$  high pulse followed by a  $0.9\mu s$  low pulse. A high bit 1 is represented by a  $0.9\mu s$  high pulse followed by a  $0.3\mu s$  low pulse. A low pulse  $\geq 200\mu s$  is used to issue a reset command to THE IC to start a new cycle of serial commands.



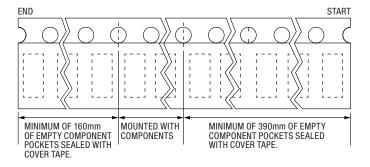


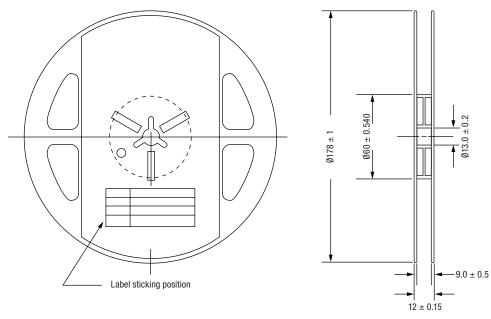
#### TAPE AND REEL SPECIFICATION



Dim A	Dim B	Dim C	Quantity/Reel
5.70±0.10	5.30±0.10	1.80±0.10	1000

Unit: mm





Unit: mm

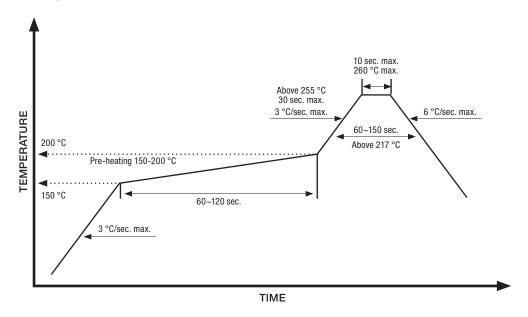


#### **REFLOW SOLDERING**

Recommended soldering paste specifications:

- 1. Operating temp.: Above 217 °C, 60~150 sec.
- 2. Peak temp.: 260 °C max, 10 sec max
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

#### LEAD-FREE SOLDER PROFILE





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